TOSHIBA Photo Coupler IRED & Photo-Triac

# TLP666GF(S)

Office machine Household use equipment Triac driver Solid State Relay

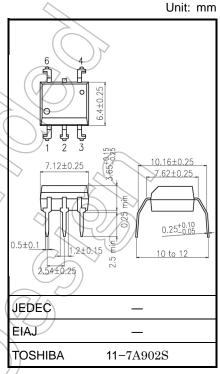
The TOSHIBA TLP666GF(S) consists of a zero voltage crossing turn—on photo–triac optically coupled to an infrared emitting diode in a six lead plastic DIP.

- Peak off-state voltage: 400V(min.)
- Trigger LED current: 10mA(max.)
- On-state current: 100mA(max.)
- Isolation voltage: 5000V<sub>rms</sub>(min.)
- UL-recognized: UL 1577, File No.E67349
- cUL-recognized: CSA Component Acceptance Service No.5A File No.E67349
- VDE- approved: EN 60747-5-5, EN 62368-1 (Note 1)

Note 1: When a VDE approved type is needed, please designate the **Option(D4)**.

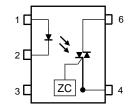
Structural parameter

	10.16 mm pich TLPXXXF,(LF2) type
Creepage distance	8.0 mm (min)
Clearance	8.0 mm (min)
Insulation thickness	0.5 mm (min)



Weight: 0.39 g(typ.)

#### Pin Configurations (top view)



- 1 : Anode
- 2 : Cathode
- 3: N.C.
- 4 : Terminal 1
- 6 : Terminal 2

Start of commercial production 1986-04



#### **Absolute Maximum Ratings (Ta = 25°C)**

Characteristic			Symbol	Rating	Unit	
	Forward current			50	mA	
Forward current derating (Ta ≥ 53°C)			ΔI <sub>F</sub> / °C	-0.7	mA / °C	
	Peak forward current (100μs pu	I <sub>FP</sub>	1	Α		
LED	Reverse voltage		VR	5	V	
	Input power dissipation		PD	100	) mw	
	Input power dissipation derating (Ta ≥ 53°C)		ΔPD/°C	1.39	mW/°C	
	Junction temperature		Tj	125	°C	
	Off-state output terminal voltage		VDRM	400	٧	
	On–state RMS current	Ta=25°C	IT(DMO)	100	mA	
	On-State Rivis current	Ta=70°C	II (RMS)	50		
ō	On-state current derating (Ta ≥ 25°C)		ΔIT / °C	-1.1	mA ∕ °C	
Detector	Peak on–state current (100μs pulse, 120pps)		(ITP)	2	A	
ă	Peak nonrepetitive surge currer	Ta=70°C	nrepetitive surge current (Pw=10ms, DC=10%) ITSM 1.2			
	Output power dissipation	Po	300	<b>≥</b>		
	Output power dissipation deration	ΔPo /°C	-3.0	mW /°C		
	Junction temperature	Tj	115	∕ °C		
Storag	Storage temperature range		T <sub>stg</sub>	-55 to 125	°C	
Operat	Operating temperature range		Topr	-40 to 100	°C	
Lead s	Lead solder temperature (10 s)		Tsold	260	°C	
Isolatio	on voltage (AC, 60 s., R.H.≤ 60 %	BVs	5000	V <sub>rms</sub>		

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: Pins 1,2 and 3 shorted together and pins 4 and 6 shorted together.

### **Recommended Operating Conditions**

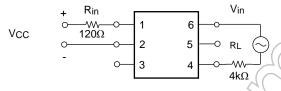
Characteristic	Symbol	Min.	Тур.	Max.	Unit
Supply voltage	V <sub>AC</sub>	_	_	120	Vac
Forward current	lF	15	20	25	mA
Peak on-state current	ITP	_	_	1	Α
Operating temperature	Topr	-25	_	85	°C

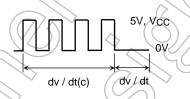
Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

### **Electrical Characteristics (Ta = 25°C)**

	Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
	Forward voltage	VF	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	IR	V <sub>R</sub> = 5 V	_	_	10	μА
	Capacitance	Ст	V = 0 V, f = 1 MHz	/_	30	_	pF
	Peak off-state current	I <sub>DRM</sub>	V <sub>DRM</sub> = 400 V		10	100	nA
	Peak on-state voltage	V <sub>TM</sub>	I <sub>TM</sub> = 100 mA		1.7	3.0	V
ctor	Holding current	lн	- ^ (7)	) <u>/</u>	0.6	_	mA
Detector	Critical rate of rise of off–state voltage	dv / dt	V <sub>in</sub> = 120 V <sub>rms</sub> , Ta = 85 °C (Note 3)	200	500	_	V / μs
	Critical rate of rise of commutating voltage	dv/dt(c)	V <sub>in</sub> = 30 V <sub>rms</sub> , I <sub>T</sub> = 15 mA (Note 3)		0.2	_	V / μs

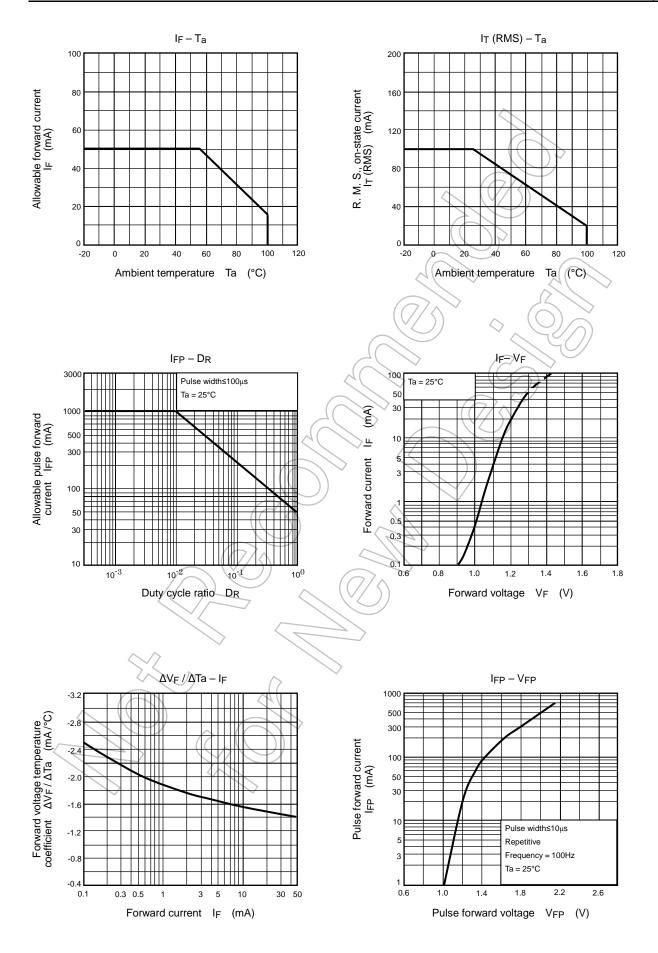
Note 3: dv / dt test circuit



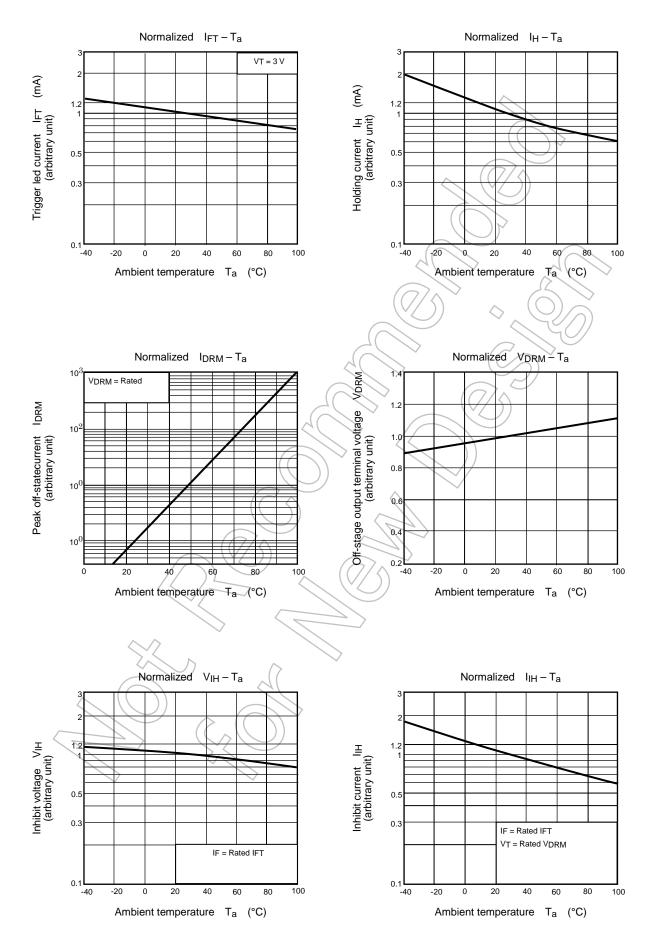


## Coupled Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	) Min.	Тур.	Max.	Unit
Trigger LED current	JET .	V <sub>T</sub> = 3 V	_	5	10	mA
Inhibit voltage	(VIH	IF = rated IFT	_	_	40	V
Leakage in inhibited state		I <sub>F</sub> = rated I <sub>FT</sub> V <sub>T</sub> = rated V <sub>DRM</sub>	_	100	300	μΑ
Capacitance (input to output)	Cs	V <sub>S</sub> = 0 V, f = 1 MHz	_	0.8	_	pF
Isolation resistance	Rs	V <sub>S</sub> = 500 V, R.H.≤ 60 %	1×10 <sup>12</sup>	10 <sup>14</sup>	_	Ω
Isolation voltage	BVs	AC, 60 s	5000	_	_	V <sub>rms</sub>



NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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